

DEVELOPMENT OF 250W EUV LIGHT SOURCE FOR HVM LITHOGRAPHY

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ABSTRACT

We have been developing CO₂-Sn-LPP EUV light source which is the most promising solution as the 13.5nm high power light source for HVM EUVL since 2003. Unique original technologies such as; combination of pulsed CO₂ laser and Sn droplets, dual wavelength laser pulse shooting and mitigation with magnetic field have been developed in Gigaphoton Inc.. The theoretical and experimental data have clearly showed the advantage of our proposed strategy. We demonstrated 117W EUV power (I/F clean in burst), 50 kHz, 22 hours stable operation at Pilot #1 device. Target of this device is 250 W EUV power by 27 kW pulsed CO₂ driver laser system.

1. Introduction

Extreme ultraviolet (EUV) light source has been being developed together with a scanning exposure tool. As the tool with 10 W EUV light source, ASML shipped "α-demo tool" in 2007¹⁾ and Nikon shipped EUV-1 in 2008²⁾. ASML has been developing β-tool; NXE-3100 in the beginning of 2011 with 100 W EUV light source.³⁾⁴⁾ Requirement of the EUV exposure tool is now in the γ-tool; NXE3300 (for high volume manufacturing (HVM))⁵⁾. Several machines are already shipped in 2013. The required EUV power is 250 W clean power (after purifying infrared (IR) and deep ultra violet (DUV) spectra) at intermediate focus (IF). However demonstrated power level is still around 80 W⁶⁾⁷⁾. In this paper we introduce latest EUV source more than 100W level EUV power demonstration by Pilot #1 system; 250W EUV source for HVM of Gigaphoton .

2. LPP EUV light source system and key components

2.1 System concept

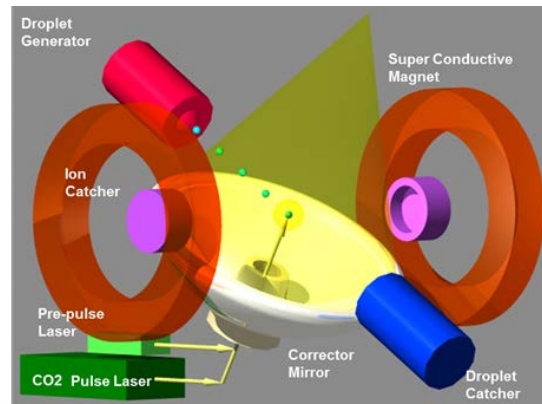


Fig. 1 The concept of Gigaphoton HVM EUV light source.

Since 2002, we have been developing the carbon dioxide (CO₂) laser produced Tin (Sn) plasma (CO₂-Sn-LPP) EUV light source which is the most promising solution as the 13.5 nm high power (>200 W) light source for HVM EUV lithography (EUVL) We have chosen the LPP-EUV method because of its high efficiency, power scalability, and spatial freedom around plasma. Our group has proposed several unique original technologies⁸⁾⁹⁾. The theoretical¹⁰⁾ and experimental¹¹⁾ data have clearly demonstrated, combination of CO₂ laser and Sn plasma realize high conversion efficiency (CE) from driver.

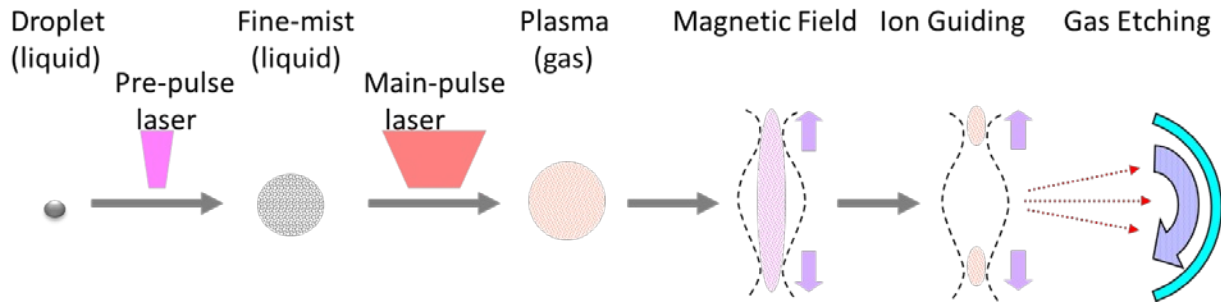


Fig. 2 EUV emission & Sn mitigation process concept.

The conceptual Structure of Gigaphoton HVM EUV light source is shown in Fig.1. And procedure of Sn debris mitigation with the magnetic field is shown in Fig. 2. At first step Sn droplet target is irradiated with pre-pulse laser. The Sn droplet is crushed to sub-micron mists. The mists are expanded in time. At second step after certain delay time the mists cloud is expanded and heated by pulsed CO₂ laser beam. The cloud is converted to high temperature plasma. Sn ions have several number of charges. During recombination process Sn plasma emits 13.5 nm EUV light. Most of the Sn ions can be trapped by the magnetic field by Larmor movement. To prevent the collector mirror from being contaminated, Sn plasma needs to be trapped before being deposited on the collector mirror. Residues of the plasma after emitting EUV light are eventually scattered inside the vessel. To enhance EUV energy and to maximize Sn debris mitigation, number of Sn ions should be maximized in these laser heating processes.

2.2 Pre-pulse technology¹²⁾¹³⁾

CE of 4.7 % with the 20 μm in diameter droplet has been demonstrated by optimizing the pre-pulse laser conditions as shown in Fig. 3 (red dot) with small experimental device. These basic studies have contributed to the development of the high-power production machine and to the basic design for further EUV power scaling together with theoretical calculations. This phenomena is explainable with difference of pre-pulse expansion mechanism of ns-pulse and ps-pulse. This high CE technology enables 250 W EUV source with 20 kW CO₂ laser.

The amount and the distribution of the Sn neutral atoms after the pre-pulse laser irradiation in a certain magnetic field were observed with the Laser Induced Fluorescence (LIF) method. On the other hand, in case of 10 ps pre-pulse ionization rate is very high even in case of low CO₂ pulse energy (Fig4).

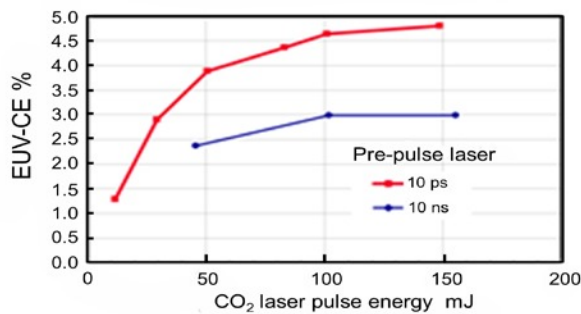


Fig.3 Conversion efficiency vs. CO₂ laser energy

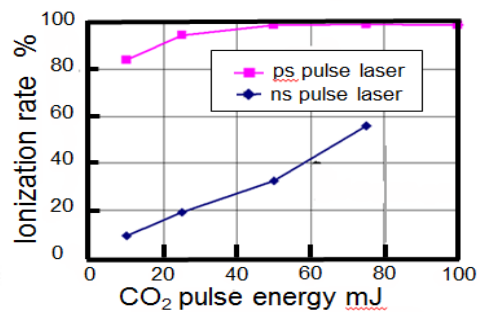


Fig.4 Ionization ratio vs. CO₂ laser energy.

2.3 Droplet generator & Magnetic-mitigation technology

Our Sn debris mitigation concept with the magnetic field is simple. Because EUV light is emitted from the Sn plasma, which is mainly composed of Sn ions and electron, almost all the Sn ions can be trapped in the strong magnetic field. Also, some neutral atoms can be guided and trapped by charge exchange with ions. In reality, however, not all the Sn atoms and ions can be trapped in the magnetic field. (Fig.5).¹³⁾ We have investigated behaviors under various conditions to optimize Sn debris mitigation parameters in the compact EUV generation tool (patented).

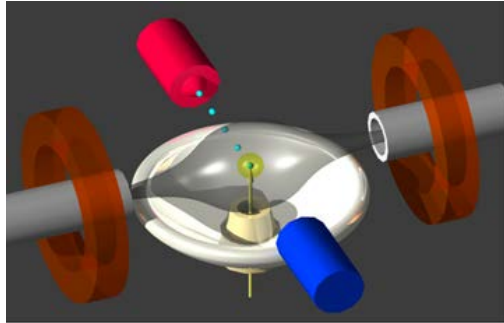


Fig.5 Collector mirror and mitigation system.

2.4 IR reduction technology on collector mirror

After EUV plasma is created, EUV light is collected by multilayer mirror. However EUV plasma emits not only EUV light, but also UV light, visible light and infrared light respectively. These light components are called “Out of band light” (Fig.6). Reflected IR light from the multilayer makes interference pattern at focal plane (patented). Only IR light is absorbed by aperture stop. Fig.7 shows the schematic of this new filter.¹⁴⁾

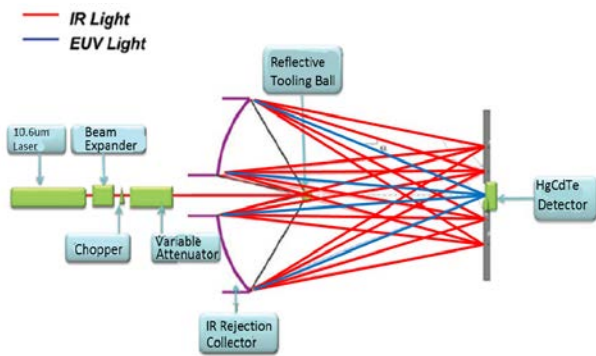


Fig. 6 Schematic of new type filter

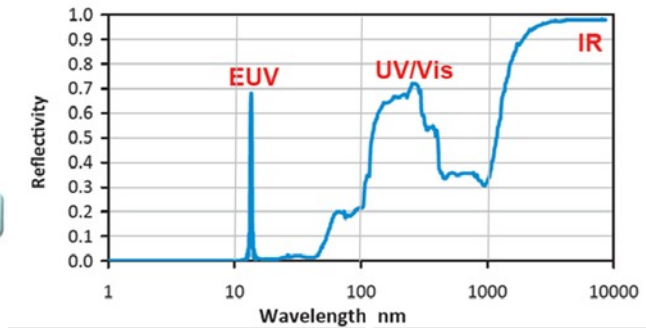


Fig.7 Out of Band spectrum.

2.5 Driver laser System development

To realize our EUV light source, we are constructed three devices; proto #1, #2 and Pilot #1. Major difference between three systems is CO₂ laser power and output angle, other specification is essentially same. We have been develop system technology and component test at proto #1 since 2011¹³⁾. The new CO₂ laser amplifier has been developed by co-operate with Mitsubishi electric supported by NEDO¹⁵⁾¹⁶⁾. We have started the construction of proto #2 system in 2H of 2013. In 2015 we succeeded to demonstrate 20 kW output power with combination of pre-amplifier by Mitsubishi electric, and other CO₂ laser by the Trumpf at proto #2 test bench¹⁷⁾. The operation has started beginning of 2014 (Fig.8). This system achieved 20kW with 15ns pulse duration, repetition rate was 100kHz. We have demonstrated 256W EUV emission in burst operation with 95% duty cycle by proto#2 device¹⁹⁾

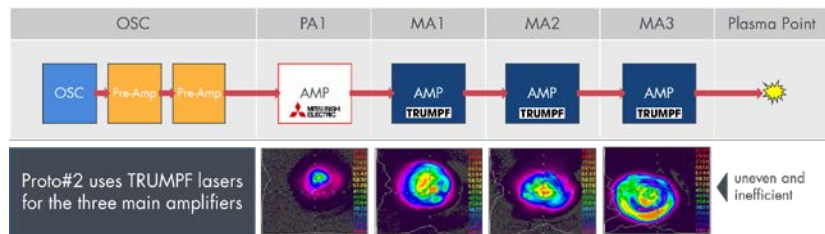


Fig.8 CO₂ laser pre-amplifier installation by Mitsubishi electric.

In 2016 we developed 27kW CO2 driver laser system for Pilot #1 system. (15ns pulse duration, repetition rate was 100kHz) composed with one pre-amplifier and three main amplifier produced by Mitsubishi electric. Picture is shown in Fig. 9. The beam profile is much better than Proto #2 CO2 driver laser system¹⁸⁾.

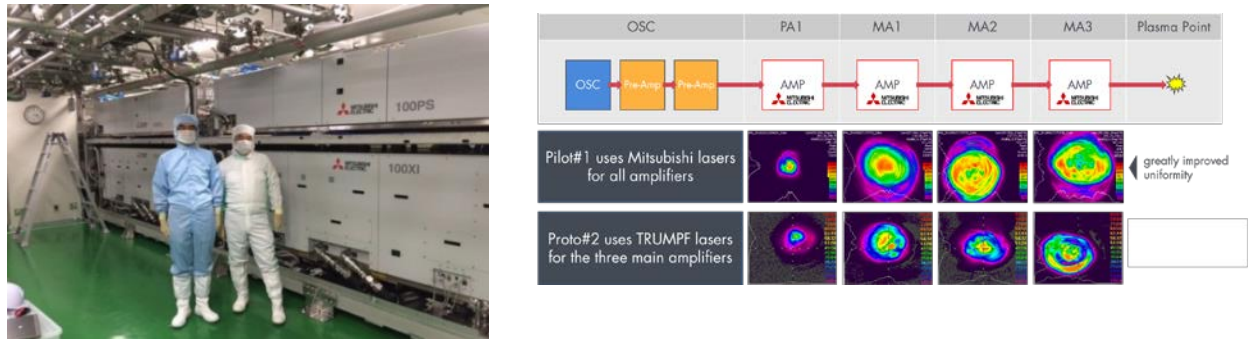


Fig.9 Pre-amplifier + 3x main amplifier installation by Mitsubishi Electric.

4. 250W HVM LPP-EUV Source¹⁹⁾²⁰⁾

4.1 Pilot #1 system construction

The Pilot#1 HVM EUV light source is shown in Fig 10. System is consist of driver laser system, beam transfer system and EUV chamber system. We are planning to use the four amplifiers which are produced by Mitsubishi electric. At present the Pilot#1 system is constructed, the picture of this construction is shown in Fig.11.

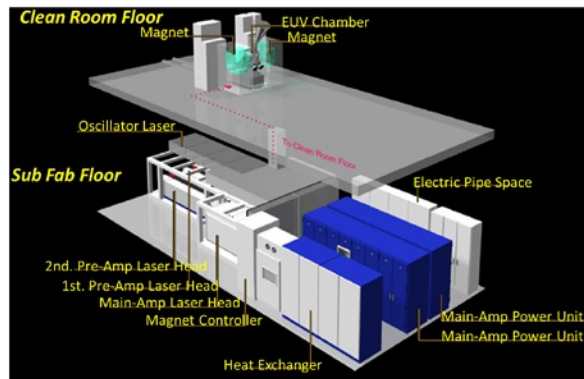


Fig.10 GL200E-Pilot#1

Table.1 Target specification of Gigaphoton EUV sources

		Proto#1 Proof of Concept	Proto#2 Key Technology	Pilot#1 HVM Ready
Target Performance	EUV Power	25W	>100W	250W
	CE	3 %	4.0 %	5.0 %
	Pulse Rate	100kHz	100kHz	100kHz
	Output Angle	Horizontal	62°upper	62°upper
	Availability	~1 week	~1 week	>75%
Technology	Droplet Generator	20 - 25µm	< 20µm	< 20µm
	CO ₂ Laser	5kW	20kW	27kW
	Pre-pulse Laser	picosecond	picosecond	picosecond
	Collector Mirror Lifetime	Used as development platform	10 days	> 3 months

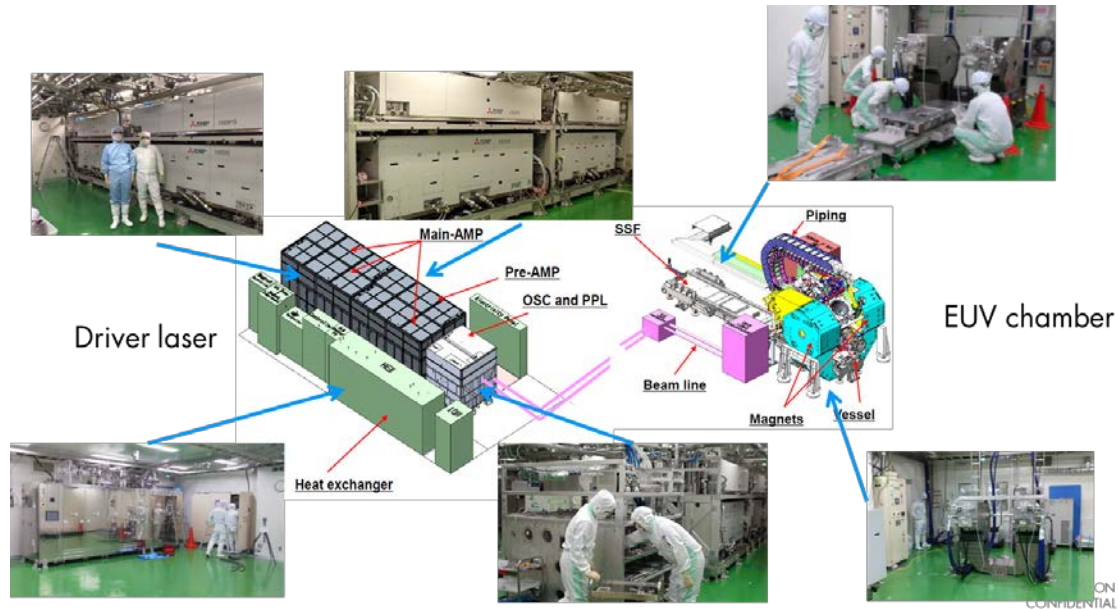


Fig. 11 Pictures of Pilot#1 system construction

4.2 High Ce fundamental experiment and actual experiment in high power device

Difference of Driver CO₂ laser beam profile of Proto #2 system and Pilot #1 is shown in fig.12. Beam profile of Pilot #1 system is much symmetrical and homogeneous. This difference make difference of conversion efficiency. Pilot #1 system achieved significant progress of conversion efficiency between 5.0% and 5.5%. This homogeneity coming from difference of excitation of CO₂ laser.

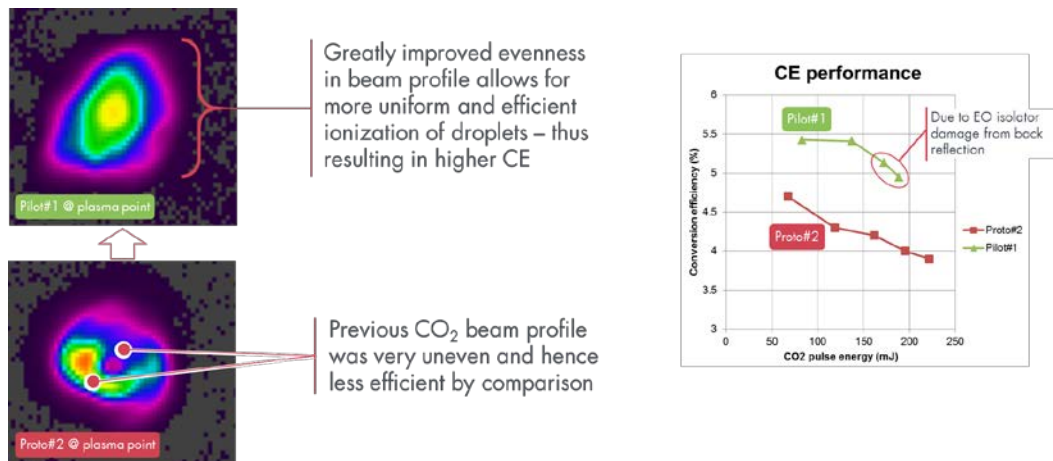


Fig.12 Driver laser beam profile and conversion efficiency

4.3 Latest data of Pilot#1 system

Since September 2016, we started the operation of Pilot #1 system. One example of the operation data of the Pilot #1 system is shown in Fig.13. EUV in band power is 117W, 95% duty cycle, 50kHz (111W average power) operation time is 22hours. CO₂ laser power is only 9.5kW, because of 5% high conversion operation. Also dose stability data is shown in Fig.14 during 22 hours. This data shows very good stability. The measured data shows 92.3% die yield.

	Performance
Conversion Efficiency	4.9%
Power (average at IF)	111W
Duty Cycle	95%
Power (in band)	117W
Operation Pulse Number	3.8Bpls
Operation Time	22hrs
Dose Margin	25%
CO ₂ Power	9.5kW
Pulse Rate	50kHz
Pulse Duration	~10ns
Availability (4 week average)	17%

Note
Although CE and average power show relatively good results, availability continues to be a gating issue. The biggest cause of this problem is the back reflection in the CO₂ laser.

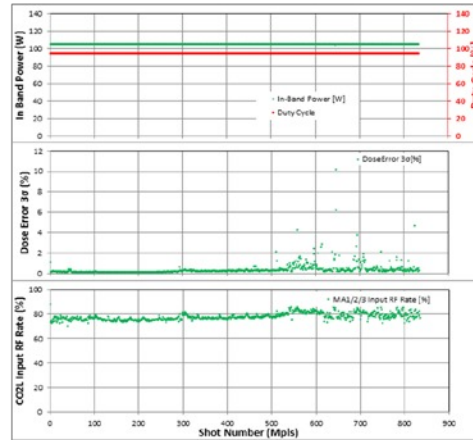


Fig.13 EUV emission data

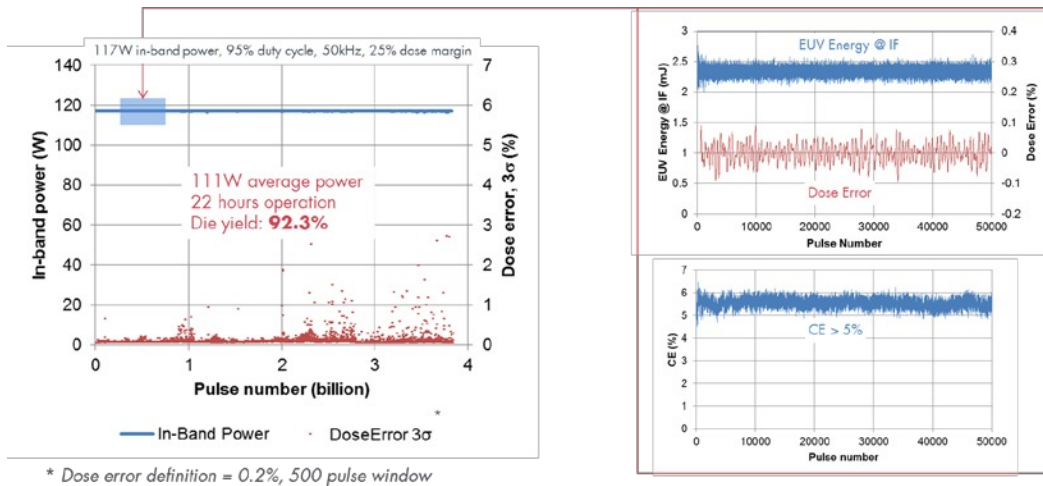


Fig.14 Dose stability data

Also thin mitigation simulation on the corrector mirror of Pilot #1 system shows significant improvement of cleanness from Proto #2 system (Fig.15), by optimized design of hydrogen gas flow on the corrector mirror. This data promise very long lifetime of the corrector mirror of Pilot #1 system.



Fig.15 Simulation of thin deposition rate on the corrector mirror

5. Conclusion

We have developed Pilot #1 system for HVM EUV lithography. We demonstrated 117W EUV power (I/F clean in burst), 50 kHz, 22 hours stable operation. This system is using 27 kW CO₂ laser amplifier system consist of pre-amplifier and 3xmain amplifiers by Mitsubishi electric in Japan. We will ship Pilot system to EUV lithography market very soon for 10nm node semiconductor mass manufacturing.

6. Acknowledgement

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